## OV13A10 13 megapixel product brief

## High-Performance 13-Megapixel PureCel®Plus-S Image Sensor Optimized for Dual-Camera Smartphone Applications

OMNIVISION's OV13A10 is an ultra-compact 13-megapixel image sensor built on OMNIVISION's second-generation, 1.0-micron PureCel ${ }^{\circledR}$ Plus-S stacked die pixel technology. Designed specifically for dual-camera applications, the OV13A10 achieves a z-height of less than 6 mm , meeting the compact space requirements of next-generation smartphones.

A customized chief ray angle (CRA) enables the OV13A10 to be used as a tele-sensor in a $2 x$ optical zoom configuration, which offers DSLR-like image quality and user experience. The OV13A10 is also optimized for dual-camera zoom solutions, with features such as context switching and frame synchronizing to simplify camera system architecture.

The OV13A10 brings a host of advanced imaging capabilities to smartphones, including zigzag high dynamic range (zHDR) and phase-detection autofocus (PDAF), which extends the sensor's dynamic range capabilities and enables snap-quick autofocus, respectively. The sensor supports multiple resolution and frame-rate configurations, including fullresolution 13-megapixel images and video at 30 frames per second (fps) with $\mathrm{zHDR}, 4 \mathrm{~K} 2 \mathrm{~K}$ video at 30 fps , and 1080p video at 60 fps .

Find out more at www.ovt.com.

## Ordering Information

- OV13A10-GA5A (color, chip probing,
$150 \mu \mathrm{~m}$ backgrinding, reconstructed wafer with good die)


## Applications

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- smartphones <br> - PC multimedia <br> - video conferencing
}


## Technical Specifications

- active array size: $4224 \times 3136$
- maximum image transfer rate:
- 4224 x 3136: 30 fps
- 4224 x 2376: 30 fps
- $2112 \times 1568: 60 \mathrm{fps}$
$-2112 \times 1188: 60 \mathrm{fps}$
- $1408 \times 792$ : 60 fps
- power supply:
- core: 1.2V
- analog: 2.8V
- I/O: 1.8 V
- power requirements:
- active: 228 mW
- standby: 1.2 mW
- XSHUTDOWN: <20 $\mu \mathrm{A}$
temperature range:
- operating: $-30^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
junction temperature
- stable: $0^{\circ} \mathrm{C}$ to $+60^{\circ} \mathrm{C}$ junction temperature
- lens size: 1/3.4"
- lens chief ray angle: $29.48^{\circ}$ non-linear
- scan mode: progressive
- pixel size: $1.008 \mu \mathrm{~m} \times 1.008 \mu \mathrm{~m}$
- image area:
$4290.05 \mu \mathrm{~m} \times 3193.34 \mu \mathrm{~m}$


## Product Features

- 13MP @ 30 fps, 4K2K @ 30 fps
- supports phase detection auto focus (PDAF) pixels with bypass PD pixels
- supports dynamic defect pixel correction (DPC)
- automatic black level calibration (ABLC)
- total embedded one-time programmable (OTP) memory: 1536 bytes
- supports typical images sizes:
- $4224 \times 3136$
- $4224 \times 2376$
- $2112 \times 1568$
- $2112 \times 1188$
- $1408 \times 792$
- supports horizontal and
vertical subsampling
- programmable I/O drive capability
- supports ZigZag HDR timing
- programmable controls for:
- frame rate
- mirror and flip
- cropping
- windowing
- up to 4-lane MIPI TX interface with speed up to 1.2 Gbps /lane
- standard serial SCCB interface with
speed up to 1 MHz
(when clock input is $>10 \mathrm{MHz}$ )
- supports output formats:
- 10-bit RAW RGB
- DPCM 10-8 compression
- long exposure time of up to 30 seconds
- two on-chip phase lock loops (PLLs)
- built-in temperature sensor
- typical module size: $8.5 \times 8.5 \mathrm{x}$ <6 mm


## Functional Block Diagram



